L	Hits	Search Text	DB	Time stamp
Number 1	511	(embed\$ near4 sensor) and metal and	USPAT;	2003/03/04
1	3.1	adhesive	US-PGPUB;	14:44
		danesive	EPO; JPO	
2	112	(embed\$ near4 sensor) and metal and	USPAT;	2003/03/04
2		(adhesive near4 (contact\$3 or layer or	US-PGPUB;	14:55
		surround\$3))	EPO; JPO	
3	1	("5996217").PN.	USPAT;	2003/03/04
3	•	, ,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	US-PGPUB;	14:47
			EPO; JPO	
4	1	("5996219").PN.	USPAT;	2003/03/04
7	•		US-PGPUB;	14:47
			EPO; JPO	
5	1	("4788406").PN.	USPAT;	2003/03/04
Ð	•	(4700400).7 14.	US-PGPUB;	14:47
			EPO; JPO	
6	69	lambads nearl cancar) and matal and	USPAT;	2003/03/04
6	pa	(embed\$ near4 sensor) and metal and	US-PGPUB;	15:21
		(adhesive near4 (contact\$3 or layer or	EPO; JPO	IJIE I
		surround\$3)) and (substrate or bulk)	USPAT;	2003/03/04
7	1	("5996219").PN.		15:39
			US-PGPUB;	15:59
_		(#4000540!!) DN	EPO; JPO	2002/02/04
8	1	("4928513").PN.	USPAT;	2003/03/04
			US-PGPUB;	15:39
			EPO; JPO	0000/44/05
-	1120	(385/12).ccls.	USPAT;	2002/11/05
			US-PGPUB;	10:14
			EPO; JPO	
-	82	(385/12).ccls. and metal and melt\$	USPAT;	2002/11/01
			US-PGPUB;	10:00
			EPO; JPO	
-	20	(385/12).ccls. and (metal or metallic) and	USPAT;	2002/11/01
		melt\$ and deposition	US-PGPUB;	10:01
		,	EPO; JPO	
-	24	(385/12).ccls. and (metal or metallic) and	USPAT;	2002/11/01
		melt\$ and (deposition or sputtering or	US-PGPUB;	10:02
		electroplating)	EPO; JPO	}
-	17	(385/12).ccls. and (metal or metallic) and	USPAT;	2002/11/01
		melt\$ and (deposition or sputtering or	US-PGPUB;	10:05
		electroplating) and layer	EPO; JPO	,
-	81	(385/12).ccls. and (metal or metallic) and	USPAT;	2002/11/01
		(melt\$ or temperature) and (deposition or	US-PGPUB;	10:06
	·	sputtering or electroplating) and layer	EPO; JPO	
-	17	(385/12).ccls. and (metal or metallic) and	USPAT;	2002/11/01
		(melt\$) and (deposition or sputtering or	US-PGPUB;	10:28
		electroplating) and layer	EPO; JPO	
•	65644	((optic or optical) near5 sensor)	USPAT;	2002/11/01
			US-PGPUB;	10:29
			EPO; JPO	
•	1738	((optic or optical) near5 sensor) and (melt\$	USPAT;	2002/11/01
		near5 (temperature or point))	US-P PUB;	10:30
		, \	EPO; JPO	

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-	414	((optic or optical) near5 sensor) and (melt\$	USPAT;	2002/11/01
		near5 (temperature or point)) and ((metal or metallic) near5 layer)	US-PGPUB; EPO; JPO	10:31
_	414	((optic or optical) near5 sensor) and (melt\$	USPAT;	2002/11/01
_		near5 (temperature or point)) and ((metal or	US-PGPUB;	10:32
į		metallic) near5 layer)	EPO; JPO	
_	414	((optic or optical) near5 sensor) and (melt\$	USPAT;	2002/11/05
-	1	near5 (temperature or point)) and ((metal or	US-PGPUB;	17:00
		metallic) near5 layer)	EPO; JPO	
_	1	("5996219").PN.	USPAT;	2002/11/05
_	•	(0000210)	US-PGPUB;	11:22
			EPO; JPO	
•	21	invar near5 adhesive	USPAT;	2002/11/05
			US-PGPUB;	11:22
			EPO; JPO	
_	925	titanium near4 adhesive	USPAT;	2002/11/05
	320		US-PGPUB;	17:11
	1		EPO; JPO	
•	90	titanium near4 adhesive and sensor	USPAT;	2002/11/05
			US-PGPUB;	17:11
			EPO; JPO	
•	90	(titanium near4 adhesive) and sensor	USPAT;	2002/11/05
			US-PGPUB;	17:12
	}		EPO; JPO	
-	1	"6196059"	USPAT;	2002/11/05
			US-PGPUB;	17:57
			EPO; JPO	
•	1	("4788406").PN.	USPAT;	2002/11/05
			US-PGPUB;	17:59
			EPO; JPO	
-	1	("4928513").PN.	USPAT;	2002/11/05
			US-PGPUB;	18:18
	}		EPO; JPO	
-	1	("5996219").PN.	USPAT;	2002/11/05
			US-PGPUB;	18:18
	}		EPO; JPO	
•	0	embedded near5 sensor near7 metal and	USPAT;	2002/11/05
		constanan	US-PGPUB;	18:26
			EPO; JPO	
•	0	embedded near5 sensor near7 metal and	USPAT;	2002/11/05
		constantan	US-PGPUB;	18:30
			EPO; JPO	
•	0	embedded near5 sensor near7 metal and	USPAT;	2002/11/05
		constanan	US-PGPUB;	18:31
			EPO; JPO	
•	2	constanan	USPAT;	2002/11/05
			US-PGPUB;	18:32
			EPO; JPO	
-	0	metal near4 embedded near5 sensor and	USPAT;	2002/11/05
		(substrate near5 steel) and stainl ss	US-PGPUB;	18:32
			EPO; JPO	

ſ <u>-</u>	0	(metal near4 embedded near5 sensor) and	USPAT;	2002/11/05
		(substrate near5 steel) and stainless	US-PGPUB;	18:33
		(Sassitute induit office)	EPO; JPO	
	0	(optic\$ near5 s nsor) and embed\$ and	USPAT;	2002/11/05
•		(titanium near5 adhesive)	US-PGPUB;	18:38
		(titalium nears auriesive)	EPO; JPO	10.00
	40700	/ 4:- 6 5 and ambade //avar	USPAT;	2002/11/05
-	18728	(optic\$ near5 sensor) and embed\$ (layer	}	18:42
		near5 adhesive) and (insulat\$ near4 layer)	US-PGPUB;	10:42
		(1170 470 4711) 701	EPO; JPO	2002/44/05
-	1	("5315245").PN.	USPAT;	2002/11/05
			US-PGPUB;	19:01
			EPO; JPO	
-	1	("4788406").PN.	USPAT;	2002/11/05
			US-PGPUB;	19:29
			EPO; JPO	
•	1	("4928513").PN.	USPAT;	2002/11/05
			US-PGPUB;	19:29
			EPO; JPO	
	42	(optic\$ near5 sensor) and (insulat\$ near5	USPAT;	2003/02/28
		layer near6 adhesive)	US-PGPUB;	12:13
			EPO; JPO	
-	0	385/12.ccis. and (insulat\$ near5 layer near6	USPAT;	2003/02/28
		adhesive)	US-PGPUB;	12:18
			EPO; JPO	
-	3	385/12.ccls. and (insulat\$ near5 layer) and	USPAT;	2003/02/28
		(adhesive near5 layer)	US-PGPUB;	12:18
			EPO; JPO	
-	53	(optic\$ near5 sensor) and embed\$ and	USPAT;	2003/02/28
		(layer near5 adhesive) and (insulat\$ near4	US-PGPUB;	12:19
		layer)	EPO; JPO	
-	19	(optic\$ near5 sensor) and (titanium near5	USPAT;	2003/02/28
		adhesive)	US-PGPUB;	12:22
			EPO; JPO	
-	2	(embedded near5 sensor) and (substrate	USPAT;	2003/02/28
	į	near5 steel) and stainless and metal	US-PGPUB;	12:26
	ļ		EPO; JPO	
	0	titanium near4 adhesive and (embedded	USPAT;	2003/02/28
		near5 sensor)	US-PGPUB;	12:26
			EPO; JPO	
_	0	385/12.ccls. and ((adhesive or epoxy or	USPAT;	2003/02/28
	}	resin) near5 layer near5 titanium)	US-PGPUB;	12:26
}		,	EPO; JPO	
	5	(embedded near5 sensor near5 metal) and	USPAT;	2003/02/28
		((adhesive or epoxy or resin) near5 layer)	US-PGPUB;	
		((aantootto or open) it tooling in jory	EPO; JPO	
_	95	embedded near5 sensor near5 metal	USPAT;	2003/02/28
_	33	CILIDUAGE HOULE CONTOUR HOUSE	US-PGPUB;	12:27
			EPO; JPO	
_	0	(embedded near5 sensor) and (metal near5	USPAT;	2003/02/28
_	J	embedded) and (adhesive near5 layer) and	US-PGPUB;	12:29
	}	, ,	EPO; JPO	
	<u> </u>	(adhesive near5 titanium)	Lru, Jru	<u> </u>

-	0	(embedded near5 sensor near5 metal) and	USPAT;	2003/02/28
		(titanium near5 adhesive)	US-PGPUB;	12:29
			EPO; JPO	
-	0	(mbedded near5 sensor) and (metal near5	USPAT;	2003/02/28
		embedded) and (adhesive near5 layer) and	US-PGPUB;	12:29
		((adhesive or melt or bond) near5 titanium)	EPO; JPO	
_	0	(embedded near5 sensor near5 metal) and	USPAT;	2003/02/28
		(adhesive near5 layer) and (titanium near5	US-PGPUB;	12:30
		layer)	EPO; JPO	
_	0	(embedded near5 sensor near5 metal) and	USPAT;	2003/02/28
		(adhesive near5 layer) and ((adhesive or	US-PGPUB;	12:30
		melt or epoxy near5 bond) near5 titanium)	EPO; JPO	
_	0	(embedded near5 sensor near5 metal) and	USPAT;	2003/02/28
		(adhesive near5 layer) and ((adhesive or	US-PGPUB;	12:30
		melt or bond) near5 titanium)	EPO; JPO	
	14	(metal near4 embed\$ near5 sensor) and	USPAT;	2003/02/28
	1	(melt\$ near4 (point or temperature))	US-PGPUB;	12:31
		/	EPO; JPO	
_	14	(metal near4 embedded near5 sensor) and	USPAT;	2003/02/28
-		(melt\$ near4 (point or temperature))	US-PGPUB;	12:31
		(merta neara (home or remberature))	EPO; JPO	
	101	metal near4 embedded near5 sensor	USPAT;	2003/02/28
-	101	metal hear4 embedded hear5 sensor	US-PGPUB;	12:31
			EPO; JPO	12:31
		//) -	2002/02/20
-	6	((optic or optical) near5 sensor) and (melt\$	USPAT;	2003/02/28
		near5 (temperature or point)) and ((metal or	US-PGPUB;	12:32
		metallic) near5 layer) and (deposition or	EPO; JPO	
		sputtering or electroplating) and (nickel or		
		copper or iron or platinum) and ((adhesive		
		or titanium) near5 layer) and (insulat\$		
		near5 layer) and substrate and ((sensor).ti.		
,		or (sensor).ab.)		
-	38	((optic or optical) near3 sensor) and (melt\$	USPAT;	2003/02/28
		near5 (temperature or point)) and ((metal or	US-PGPUB;	12:33
		metallic) near5 layer) and (deposition or	EPO; JPO	
		sputtering or electroplating) and (nickel or		
		copper or iron or platinum) and ((adhesive		
		or titanium) near5 layer) and (insulat\$		
		near5 layer) and substrate		
-	38	((optic or optical) near5 sensor) and (melt\$	USPAT;	2003/02/28
		near5 (temperature or point)) and ((metal or	US-PGPUB;	12:37
		metallic) near5 layer) and (deposition or	EPO; JPO	
		sputtering or electroplating) and (nickel or		
		copper or iron or platinum) and ((adhesive		
		or titanium) near5 layer) and (insulat\$		
		near5 layer) and substrate		
	71	((optic or optical) near5 sensor) and (melt\$	USPAT;	2003/02/28
-	1		ua nanun	42-42
-		near5 (temperature or point)) and ((metal or	US-PGPUB;	12:42
-		near5 (temperature or point)) and ((metal or metallic) near5 layer) and (depositi n or	EPO; JPO	12:42
-				12:42
-		metallic) near5 layer) and (depositi n or		12:42

	176	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum) and (adhesive or titanium)	USPAT; US-PGPUB; EP ; JPO	2003/02/28 12:45
	228	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating) and (nickel or copper or iron or platinum)	USPAT; US-PGPUB; EPO; JPO	2003/02/28 12:49
-	286	((optic or optical) near5 sensor) and (melt\$ near5 (temperature or point)) and ((metal or metallic) near5 layer) and (deposition or sputtering or electroplating)	USPAT; US-PGPUB; EPO; JPO	2003/02/28 12:52